TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74HC564AP, TC74HC564AF TC74HC574AP, TC74HC574AF

Octal D-Type Filp-Flop with 3-State Output

TC74HC564AP/AF Inverting

TC74HC574AP/AF Non-Inverting

The TC74HC564A and HC574A are high speed CMOS OCTAL FLIP-FLOPs with 3-STATE OUTPUT fabricated with silicon gate  $\rm C^2MOS$  technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

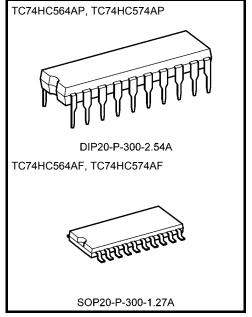
These 8-bit D-type flip-flops are controlled by a clock input (CK) and an output enable input ( $\overline{OE}$ ).

The TC74HC564A has inverting outputs, and the TC74HC574A has non-inverting outputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

- High speed:  $f_{max} = 62 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 6 mA (min)
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: V<sub>CC</sub> (opr) = 2 to 6 V
- Pin and function compatible with 74LS564/574

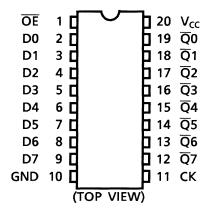


Weight

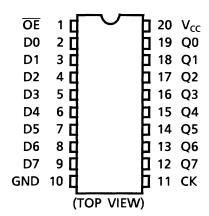
DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.)

## **Pin Assignment**

#### **TC74HC564A**

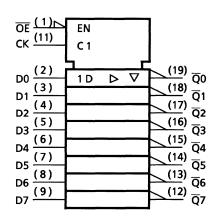


#### **TC74HC574A**

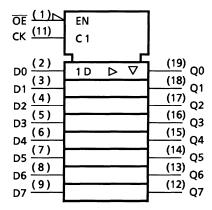


### **IEC Logic Symbol**

#### **TC74HC564A**



#### TC74HC574A



#### **Truth Table**

	Inputs		Outputs				
ŌĒ	CK	D	Q (574A)	Q (564A)			
Н	Х	Х	Z	Z			
L	$\neg$	Х	Qn	$\overline{Q}_n$			
L		L	L	Н			
L		Н	Н	L			

X: Don't care

Z: High impedance

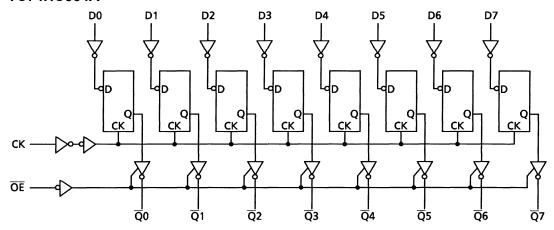
 $Q_n(\overline{Q}_n)$ : No change

2

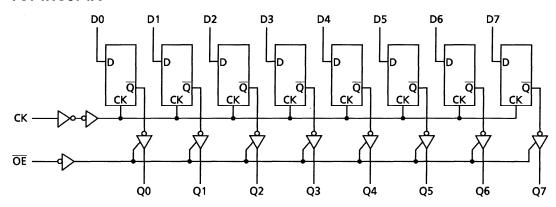


#### System Diagram

#### **TC74HC564A**



#### **TC74HC574A**



#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	–0.5 to 7	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	−0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to  $65^{\circ}C$ . From Ta = 65 to  $85^{\circ}C$  a derating factor of -10 mW/°C shall be applied until 300 mW.



# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
Sharastonsus	Cymbol			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	OTING
		_		2.0	1.50	_	_	1.50	_	
High-level input voltage	$V_{IH}$			4.5	3.15	_	_	3.15	_	V
				6.0	4.20	_	_	4.20	_	
L and land lines 4				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V <sub>IL</sub>		_		_	_	1.35		1.35	V
				6.0		_	1.80	_	1.80	
	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	1.9	2.0	_	1.9	_	
			I <sub>OH</sub> = -20 μA	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
			$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
	Vol.	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage				6.0	_	0.0	0.1	_	0.1	V
			I <sub>OL</sub> = 6 mA	4.5	_	0.17	0.26	_	0.33	
			$I_{OL} = 7.8 \text{ mA}$	6.0	_	0.18	0.26	_	0.33	
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		6.0		_	±0.5	_	±5.0	μΑ
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0		_	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	4.0	_	40.0	μΑ

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# Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Ta =	25°C	Ta = -40 to 85°C	Unit		
			V <sub>CC</sub> (V)	Тур.	Limit	Limit		
Minimum pulse width	<b>t</b> a.n		2.0	_	75	95		
(CK)	t <sub>W (H)</sub>	_	4.5	_	15	19	ns	
(CK)	t <sub>W (L)</sub>		6.0	_	13	16		
Minimum act un timo			2.0	_	75	95		
Minimum set-up time	t <sub>s</sub>	_	4.5	_	15	19	ns	
(Dn)			6.0	_	13	16		
Minimum hold time			2.0	_	0	0		
	t <sub>h</sub>	_	4.5	_	0	0	ns	
(Dn)			6.0	_	0	0		
			2.0	_	6	5		
Clock frequency	f	_	4.5	_	31	24	MHz	
			6.0	_	36	28		



#### AC Characteristics (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
			CL (pF)	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
0 1 11 "" "	t <sub>TLH</sub>	t <sub>TLH</sub>	50	2.0	_	25 7	60 12	_	75 15	
Output transition time	t <sub>THL</sub>	_	50	4.5 6.0		6	10	_	13	ns
				2.0	_	70	150	_	190	
			50	4.5	_	20	30	_	38	
Propagation delay time	t <sub>pLH</sub>			6.0	_	15	26		33	20
(CK-Q, $\overline{Q}$ )	$t_{pHL}$	_		2.0	_	88	190	_	240	ns
(3.1 4, 4)			150	4.5	_	25	38	_	48	
				6.0	_	19	33	_	41	
	<sup>t</sup> pZL <sup>t</sup> pZH	R <sub>L</sub> = 1 kΩ	50	2.0	_	48	125	_	155	- ns
				4.5	_	15	25	_	31	
Output enable time				6.0		12	21	_	26	
Output enable time			150	2.0		60	165	_	205	
				4.5	_	20	33		41	
				6.0		16	28	_	35	
	t <sub>pLZ</sub>			2.0	_	34	125		155	
Output disable time		$R_L = 1 \text{ k}\Omega$	50	4.5	_	17	25	_	31	ns
	t <sub>pHZ</sub>			6.0		15	21	_	26	
				2.0	6	17	_	5	_	
Maximum clock frequency	f <sub>max</sub>	_	50	4.5	31	50	_	24	_	MHz
- 4 7				6.0	36	59	_	28	_	
Input capacitance	C <sub>IN</sub>		-			5	10	_	10	pF
Output capacitance	C <sub>OUT</sub>					10		_		pF
Power dissipation capacitance	C <sub>PD</sub> (Note)		-			54		_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8$  (per bit)

And the total  $C_{\mbox{\scriptsize PD}}$  when n pcs. of flip flop operate can be gained by the following equation:

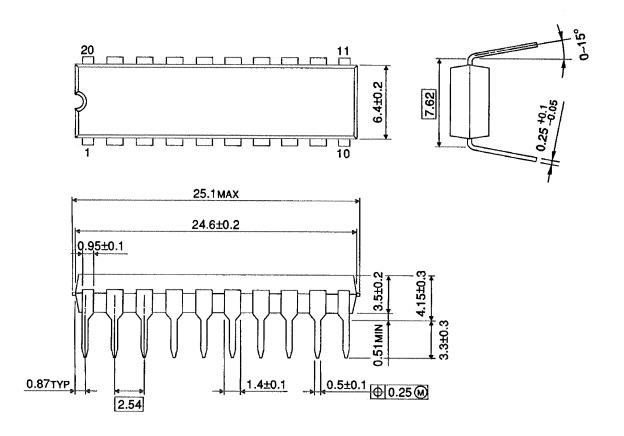
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$$C_{PD}$$
 (total) = 39 + 15 · n



# **Package Dimensions**

DIP20-P-300-2.54A Unit: mm

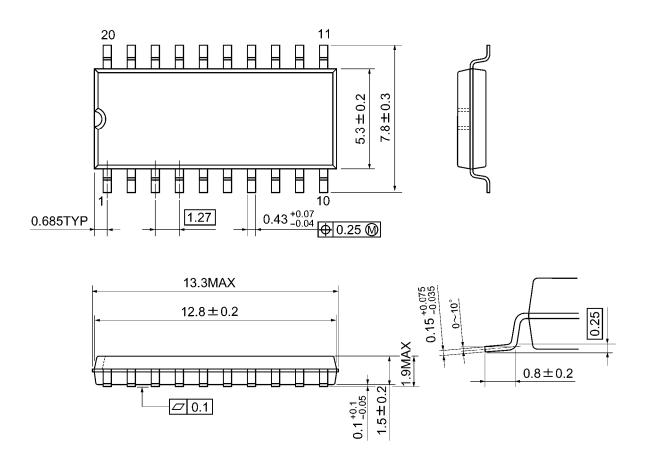


Weight: 1.30 g (typ.)



# **Package Dimensions**

SOP20-P-300-1.27A Unit: mm



8

Weight: 0.22 g (typ.)

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